# ANALOG Product/Process Change Notice - PCN 13\_0255 Rev. A

Analog Devices, Inc. Three Technology Way Norwood, Massachusetts 02062-9106

This notice is to inform you of a change that will be made to certain ADI products (see Material Report). Any issues with this PCN or requirements to qualify the change (additional data or samples) must be sent to ADI within 30 days of publication date. ADI contact information is listed below.

Note: Revised fields are indicated by a red field name. See Appendix B for revision history.

PCN Title:	Assembly and Test Transfer of Select 5x5mm LFCSP Products using Copper Wire to STATS ChipPAC China	
Publication Date:	23-Jul-2014	
Effectivity Date:	18-May-2014 (the earliest date that a customer could expect to receive changed material)	

#### **Revision Description:**

Include Qualification and Test Correlation Report Summary

## Description Of Change

ADI is transferring to subcontractor STATS ChipPAC China for the assembly and test manufacturing of select 5x5mm LFCSP products using copper wire. The package outline dimensions and BOM of each product will be maintained.

#### Reason For Change

ADI is transferring to STATS ChipPAC China due to the closure of STATS ChipPAC Malaysia at the end of 2014.

ADI's assembly subcontractors manufacture products using Analog Devices specified manufacturing flows, materials, process controls and monitors, ensuring the same level of quality and reliability on products they receive from the new site.

### Impact of the change (positive or negative) on fit, form, function & reliability

The transfer will have no impact on the form, fit, function and reliability of the devices.

**Product Identification** (this section will describe how to identify the changed material)

The parts that will be assembled after the transfer will be identified by assembly lot and the country of origin.

#### Summary of Supporting Information

Qualification has been performed per ADI0012, Procedure for Qualification of New or Revised Processes. See attached Qualification Report Summary.

Test correlation and validation is completed. Please see the attached list for the Test Correlation Report Summary.

# **Supporting Documents**

Attachment 1: Type: Qualification Results Summary ADI PCN 13 0255 Rev A Qualification Results Summary.pdf

Attachment 2: Type: Test Correlation Report

Attachment 3: Type: Detailed Change Description ADI\_PCN\_13\_0255\_Rev\_A\_BOM .pptx

For questions on this PCN, send email to the regional contacts below or contact your local ADI sales representative							
Americas:	PCN_Americas@analog.com	Europe:	PCN_Europe@analog.com	Japan: Rest of Asia:	PCN_Japan@analog.com PCN_ROA@analog.com		

Appendix A - Affected ADI Models					
Existing Parts - Product Family / Model Number (1)					
ADP1877 / ADP1877ACPZ-R7					

Appendix B - Revision History							
Rev	Publish Date	Effectivity Date	Rev Description				
Rev	07-Nov-2013	18-May-2014	Initial Release				
Rev. A	23-Jul-2014	18-May-2014	Include Qualification and Test Correlation Report Summary				
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Analog Devices, Inc.